

MJE13007

Switch-mode NPN Bipolar Power Transistor

For Switching Power Supply Applications

The MJE13007 is designed for high-voltage, high-speed power switching inductive circuits where fall time is critical. It is particularly suited for 115 and 220 V switch-mode applications such as Switching Regulators, Inverters, Motor Controls, Solenoid/Relay drivers and Deflection circuits.

Features

- SOA and Switching Applications Information
- Standard TO-220
- These Devices are Pb-Free and are RoHS Compliant*
- Complementary to the MJE5850 through MJE5852 Series

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Sustaining Voltage	V_{CEO}	400	Vdc
Collector-Base Breakdown Voltage	V_{CES}	700	Vdc
Emitter-Base Voltage	V_{EBO}	9.0	Vdc
Collector Current – Continuous	I_C	8.0	Adc
Collector Current – Peak (Note 1)	I_{CM}	16	Adc
Base Current – Continuous	I_B	4.0	Adc
Base Current – Peak (Note 1)	I_{BM}	8.0	Adc
Emitter Current – Continuous	I_E	12	Adc
Emitter Current – Peak (Note 1)	I_{EM}	24	Adc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	80 0.64	W W/ $^\circ\text{C}$
Operating and Storage Temperature	T_J, T_{stg}	-65 to 150	$^\circ\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Pulse Test: Pulse Width = 5 ms, Duty Cycle $\leq 10\%$.

THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.56	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	$^\circ\text{C/W}$
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 5 Seconds	T_L	260	$^\circ\text{C}$

*Measurement made with thermocouple contacting the bottom insulated mounting surface of the package (in a location beneath the die), the device mounted on a heatsink with thermal grease applied at a mounting torque of 6 to 8 lbs.

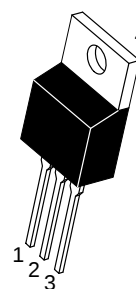
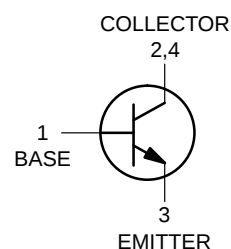
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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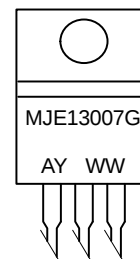
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POWER TRANSISTOR
8.0 AMPERES
400 VOLTS – 80 WATTS



TO-220AB
CASE 221A-09
STYLE 1

MARKING DIAGRAM



A = Assembly Location
Y = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
MJE13007G	TO-220 (Pb-Free)	50 Units / Rail

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS (Note 2)

Collector–Emitter Sustaining Voltage ($I_C = 10\text{ mA}$, $I_B = 0$)	$V_{CEO(sus)}$	400	–	–	Vdc
Collector Cutoff Current ($V_{CES} = 700\text{ Vdc}$) ($V_{CES} = 700\text{ Vdc}$, $T_C = 125^\circ\text{C}$)	I_{CES}	– –	– –	0.1 1.0	mAdc
Emitter Cutoff Current ($V_{EB} = 9.0\text{ Vdc}$, $I_C = 0$)	I_{EBO}	–	–	100	μAdc

SECOND BREAKDOWN

Second Breakdown Collector Current with Base Forward Biased	$I_{S/b}$	See Figure 6			
Clamped Inductive SOA with Base Reverse Biased	–	See Figure 7			

ON CHARACTERISTICS (Note 2)

DC Current Gain ($I_C = 2.0\text{ Adc}$, $V_{CE} = 5.0\text{ Vdc}$) ($I_C = 5.0\text{ Adc}$, $V_{CE} = 5.0\text{ Vdc}$)	h_{FE}	8.0 5.0	– –	40 30	–
Collector–Emitter Saturation Voltage ($I_C = 2.0\text{ Adc}$, $I_B = 0.4\text{ Adc}$) ($I_C = 5.0\text{ Adc}$, $I_B = 1.0\text{ Adc}$) ($I_C = 8.0\text{ Adc}$, $I_B = 2.0\text{ Adc}$) ($I_C = 5.0\text{ Adc}$, $I_B = 1.0\text{ Adc}$, $T_C = 100^\circ\text{C}$)	$V_{CE(sat)}$	– – – –	– – – –	1.0 2.0 3.0 3.0	Vdc
Base–Emitter Saturation Voltage ($I_C = 2.0\text{ Adc}$, $I_B = 0.4\text{ Adc}$) ($I_C = 5.0\text{ Adc}$, $I_B = 1.0\text{ Adc}$) ($I_C = 5.0\text{ Adc}$, $I_B = 1.0\text{ Adc}$, $T_C = 100^\circ\text{C}$)	$V_{BE(sat)}$	– – –	– – –	1.2 1.6 1.5	Vdc

DYNAMIC CHARACTERISTICS

Current–Gain – Bandwidth Product ($I_C = 500\text{ mAdc}$, $V_{CE} = 10\text{ Vdc}$, $f = 1.0\text{ MHz}$)	f_T	4.0	14	–	MHz
Output Capacitance ($V_{CB} = 10\text{ Vdc}$, $I_E = 0$, $f = 0.1\text{ MHz}$)	C_{ob}	–	80	–	pF

SWITCHING CHARACTERISTICS

Resistive Load (Table 1)							
Delay Time	$(V_{CC} = 125\text{ Vdc}, I_C = 5.0\text{ A}, I_{B1} = I_{B2} = 1.0\text{ A}, t_p = 25\text{ }\mu\text{s}, \text{Duty Cycle} \leq 1.0\%)$		t_d	–	0.025	0.1	μs
Rise Time			t_r	–	0.5	1.5	
Storage Time			t_s	–	1.8	3.0	
Fall Time			t_f	–	0.23	0.7	
Inductive Load, Clamped (Table 1)							
Voltage Storage Time	$V_{CC} = 15\text{ Vdc}, I_C = 5.0\text{ A}$ $V_{\text{clamp}} = 300\text{ Vdc}$	$T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	t_{sv}	– –	1.2 1.6	2.0 3.0	μs
Crossover Time	$I_{B(\text{on})} = 1.0\text{ A}, I_{B(\text{off})} = 2.5\text{ A}$ $L_C = 200\text{ }\mu\text{H}$	$T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	t_c	– –	0.15 0.21	0.30 0.50	μs
Fall Time		$T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	t_{fi}	– –	0.04 0.10	0.12 0.20	μs

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: Pulse Width $\leq 300\text{ }\mu\text{s}$, Duty Cycle $\leq 2.0\%$.

TYPICAL CHARACTERISTICS

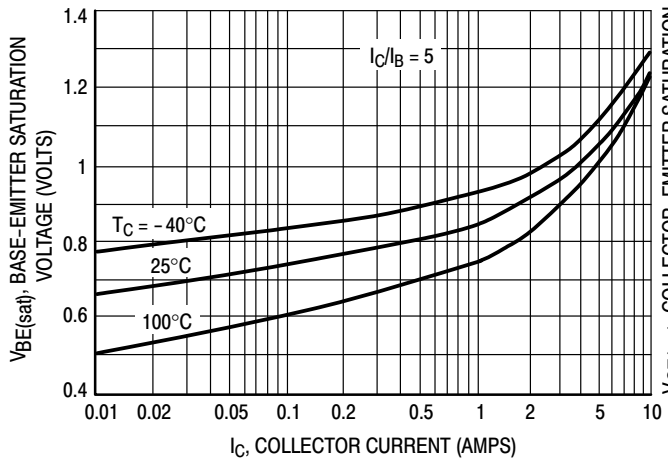


Figure 1. Base-Emitter Saturation Voltage

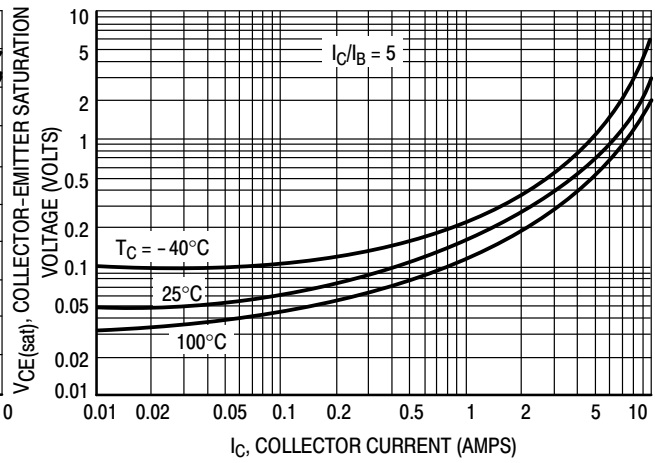


Figure 2. Collector-Emitter Saturation Voltage

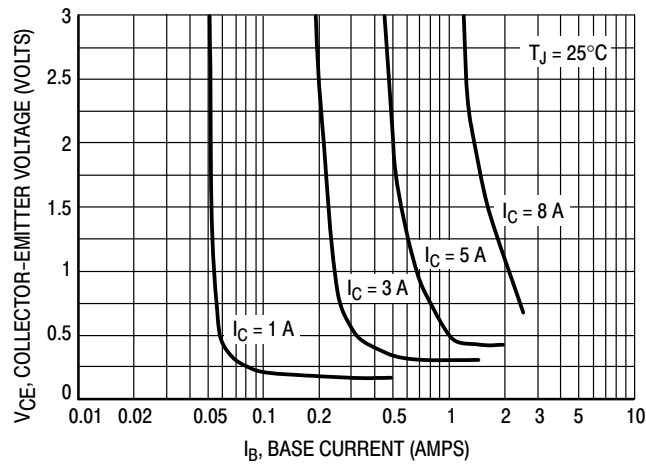


Figure 3. Collector Saturation Region

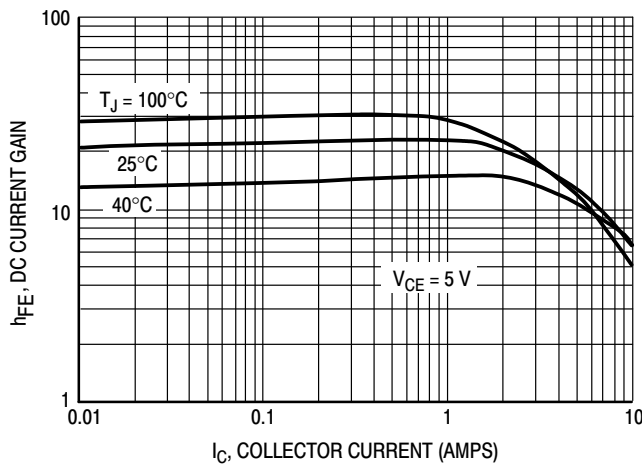


Figure 4. DC Current Gain

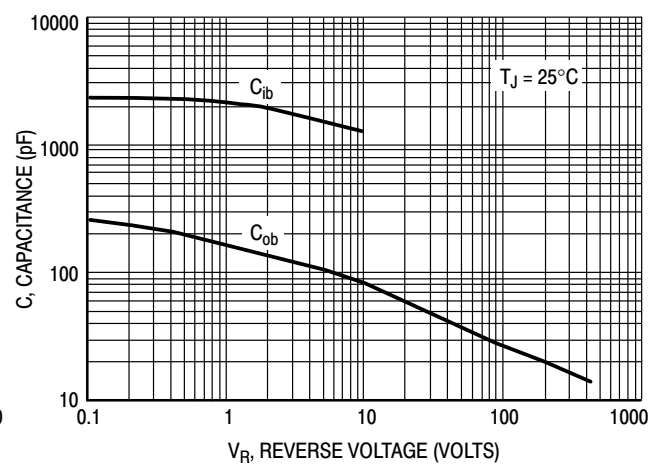


Figure 5. Capacitance

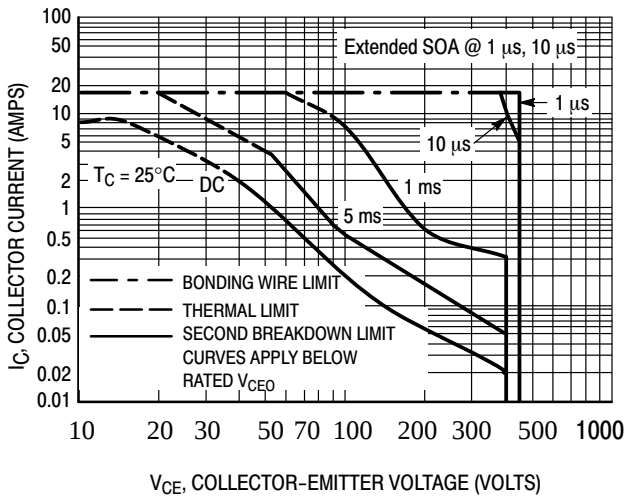


Figure 6. Maximum Forward Bias Safe Operating Area

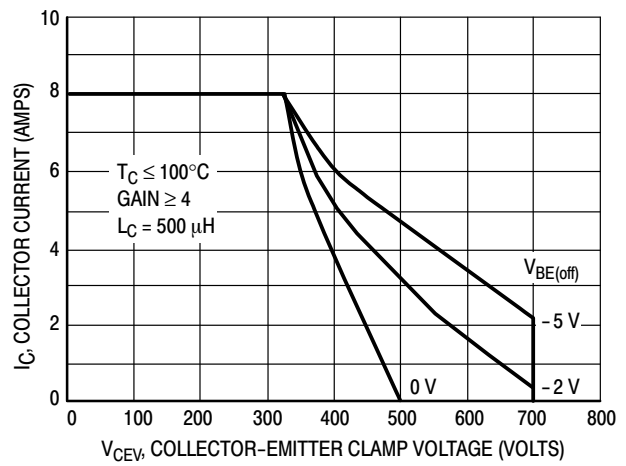


Figure 7. Maximum Reverse Bias Switching Safe Operating Area

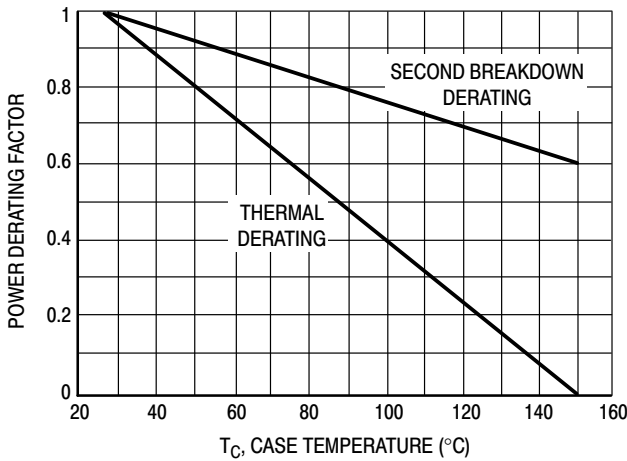


Figure 8. Forward Bias Power Derating

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 6 is based on $T_C = 25^\circ\text{C}$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \geq 25^\circ\text{C}$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 6 may be found at any case temperature by using the appropriate curve on Figure 8.

At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

Use of reverse biased safe operating area data (Figure 7) is discussed in the applications information section.

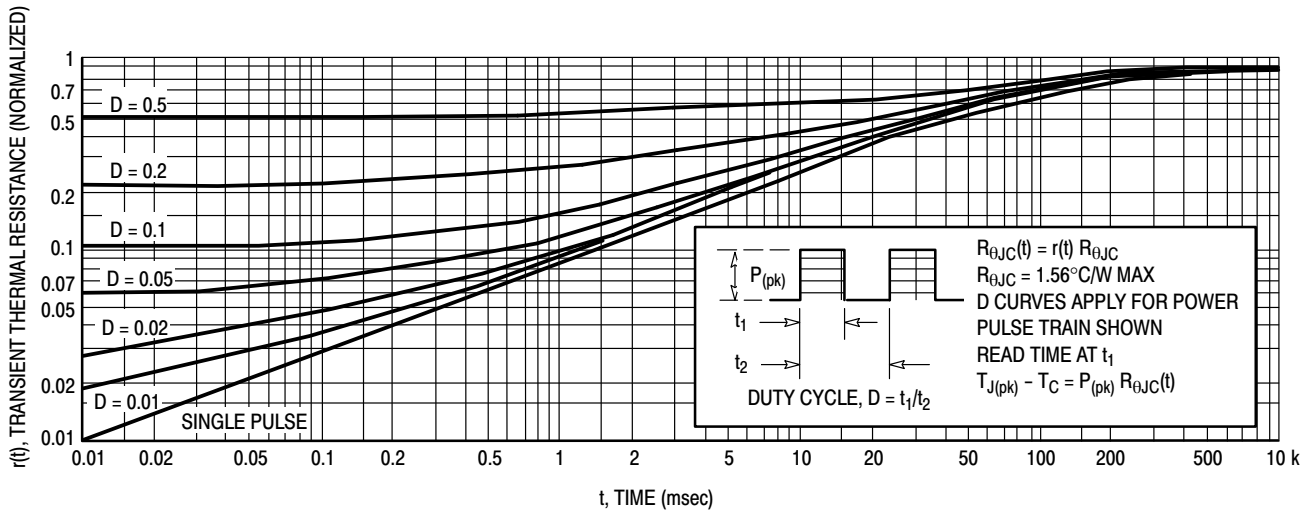


Figure 9. Typical Thermal Response for MJE13007

SPECIFICATION INFORMATION FOR SWITCHMODE APPLICATIONS

INTRODUCTION

The primary considerations when selecting a power transistor for SWITCHMODE applications are voltage and current ratings, switching speed, and energy handling capability. In this section, these specifications will be discussed and related to the circuit examples illustrated in Table 2. (Note 1)

VOLTAGE REQUIREMENTS

Both blocking voltage and sustaining voltage are important in SWITCHMODE applications.

Circuits B and C in Table 2 illustrate applications that require high blocking voltage capability. In both circuits the switching transistor is subjected to voltages substantially higher than V_{CC} after the device is completely off (see load line diagrams at $I_C = I_{leakage} \approx 0$ in Table 2). The blocking capability at this point depends on the base to emitter conditions and the device junction temperature. Since the highest device capability occurs when the base to emitter junction is reverse biased (V_{CEV}), this is the recommended and specified use condition. Maximum I_{CEV} at rated V_{CEV} is specified at a relatively low reverse bias (1.5 Volts) both

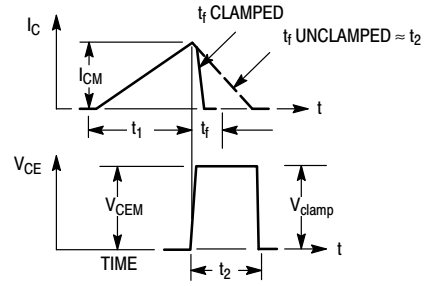
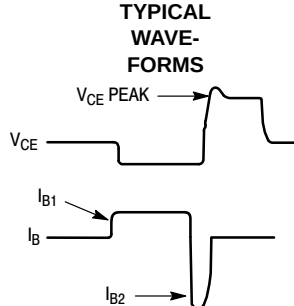
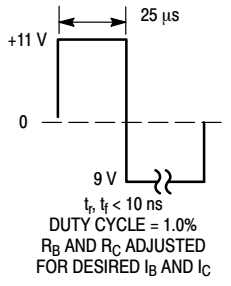
at 25°C and 100°C. Increasing the reverse bias will give some improvement in device blocking capability.

The sustaining or active region voltage requirements in switching applications occur during turn-on and turn-off. If the load contains a significant capacitive component, high current and voltage can exist simultaneously during turn-on and the pulsed forward bias SOA curves (Figure 6) are the proper design limits.

For inductive loads, high voltage and current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as a Reverse Bias Safe Operating Area (Figure 7) which represents voltage-current conditions that can be sustained during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode.

NOTE: 1. For detailed information on specific switching applications, see ON Semiconductor Application Note AN719, AN873, AN875, AN951.

Table 1. Test Conditions For Dynamic Performance

TEST CIRCUITS	REVERSE BIAS SAFE OPERATING AREA AND INDUCTIVE SWITCHING	RESISTIVE SWITCHING						
CIRCUIT VALUES	<table border="1" data-bbox="446 661 933 850"> <thead> <tr> <th>$V_{(BR)CEO(sus)}$</th><th>Inductive Switching</th><th>RBSOA</th></tr> </thead> <tbody> <tr> <td>L = 10 mH $R_{B2} = 8$ $V_{CC} = 20$ Volts $I_{C(pk)} = 100$ mA</td><td>L = 200 mH $R_{B2} = 0$ $V_{CC} = 15$ Volts R_{B1} selected for desired I_{B1}</td><td>L = 500 mH $R_{B2} = 0$ $V_{CC} = 15$ Volts R_{B1} selected for desired I_{B1}</td></tr> </tbody> </table>	$V_{(BR)CEO(sus)}$	Inductive Switching	RBSOA	L = 10 mH $R_{B2} = 8$ $V_{CC} = 20$ Volts $I_{C(pk)} = 100$ mA	L = 200 mH $R_{B2} = 0$ $V_{CC} = 15$ Volts R_{B1} selected for desired I_{B1}	L = 500 mH $R_{B2} = 0$ $V_{CC} = 15$ Volts R_{B1} selected for desired I_{B1}	$V_{CC} = 125$ V $R_C = 25$ $D = 1N5820$ OR EQUIV.
$V_{(BR)CEO(sus)}$	Inductive Switching	RBSOA						
L = 10 mH $R_{B2} = 8$ $V_{CC} = 20$ Volts $I_{C(pk)} = 100$ mA	L = 200 mH $R_{B2} = 0$ $V_{CC} = 15$ Volts R_{B1} selected for desired I_{B1}	L = 500 mH $R_{B2} = 0$ $V_{CC} = 15$ Volts R_{B1} selected for desired I_{B1}						
TEST WAVEFORMS	 t_1 ADJUSTED TO OBTAIN I_C $t_1 \approx \frac{L_{coil}(I_{CM})}{V_{CC}}$ $t_2 \approx \frac{L_{coil}(I_{CM})}{V_{clamp}}$ TEST EQUIPMENT SCOPE — TEKTRONIX 475 OR EQUIVALENT TYPICAL WAVEFORMS 	 DUTY CYCLE = 1.0% R_B AND R_C ADJUSTED FOR DESIRED I_B AND I_C						

VOLTAGE REQUIREMENTS (continued)

In the four application examples (Table 2) load lines are shown in relation to the pulsed forward and reverse biased SOA curves.

In circuits A and D, inductive reactance is clamped by the diodes shown. In circuits B and C the voltage is clamped by the output rectifiers, however, the voltage induced in the primary leakage inductance is not clamped by these diodes and could be large enough to destroy the device. A snubber network or an additional clamp may be required to keep the turn-off load line within the Reverse Bias SOA curve.

Load lines that fall within the pulsed forward biased SOA curve during turn-on and within the reverse bias SOA curve during turn-off are considered safe, with the following assumptions:

1. The device thermal limitations are not exceeded.
2. The turn-on time does not exceed 10 μ s (see standard pulsed forward SOA curves in Figure 6).
3. The base drive conditions are within the specified limits shown on the Reverse Bias SOA curve (Figure 7).

CURRENT REQUIREMENTS

An efficient switching transistor must operate at the required current level with good fall time, high energy handling capability and low saturation voltage. On this data sheet, these parameters have been specified at 5.0 amperes which represents typical design conditions for these devices. The current drive requirements are usually dictated by the $V_{CE(sat)}$ specification because the maximum saturation voltage is specified at a forced gain condition which must be duplicated or exceeded in the application to control the saturation voltage.

SWITCHING REQUIREMENTS

In many switching applications, a major portion of the transistor power dissipation occurs during the fall time (t_{fi}). For this reason considerable effort is usually devoted to reducing the fall time. The recommended way to accomplish this is to reverse bias the base-emitter junction during turn-off. The reverse biased switching characteristics for inductive loads are shown in Figures 12 and 13 and resistive loads in Figures 10 and 11. Usually the inductive load components will be the dominant factor in SWITCHMODE applications and the inductive switching data will more closely represent the device performance in actual application. The inductive switching characteristics are derived from the same circuit used to specify the reverse biased SOA curves, (see Table 1) providing correlation between test procedures and actual use conditions.

SWITCHING TIME NOTES

In resistive switching circuits, rise, fall, and storage times have been defined and apply to both current and voltage waveforms since they are in phase. However, for inductive loads which are common to SWITCHMODE power supplies and any coil driver, current and voltage waveforms are not in phase. Therefore, separate measurements must be made on each waveform to determine the total switching time. For this reason, the following new terms have been defined.

t_{sv} = Voltage Storage Time, 90% I_{B1} to 10% V_{clamp}

t_{rv} = Voltage Rise Time, 10–90% V_{clamp}

t_{fi} = Current Fall Time, 90–10% I_C

t_{ti} = Current Tail, 10–2% I_C

t_c = Crossover Time, 10% V_{clamp} to 10% I_C

An enlarged portion of the turn-off waveforms is shown in Figure 12 to aid in the visual identity of these terms. For the designer, there is minimal switching loss during storage time and the predominant switching power losses occur during the crossover interval and can be obtained using the standard equation from AN222A:

$$P_{SWT} = 1/2 V_{CC} I_C (t_c) f$$

Typical inductive switching times are shown in Figure 13. In general, $t_{rv} + t_{fi} \approx t_c$. However, at lower test currents this relationship may not be valid.

As is common with most switching transistors, resistive switching is specified at 25°C and has become a benchmark for designers. However, for designers of high frequency converter circuits, the user oriented specifications which make this a “SWITCHMODE” transistor are the inductive switching speeds (t_c and t_{sv}) which are guaranteed at 100°C.

SWITCHING PERFORMANCE

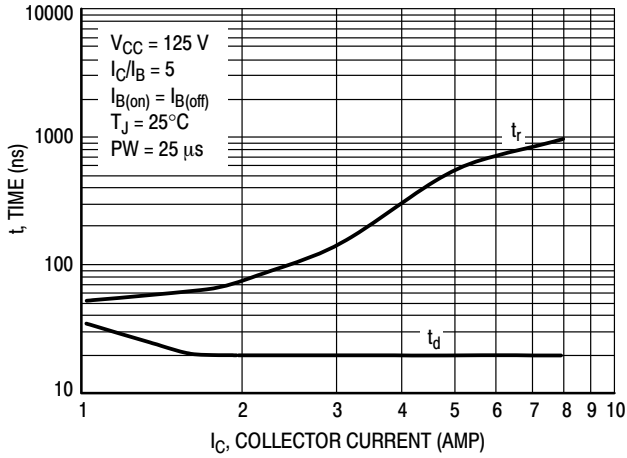


Figure 10. Turn-On Time (Resistive Load)

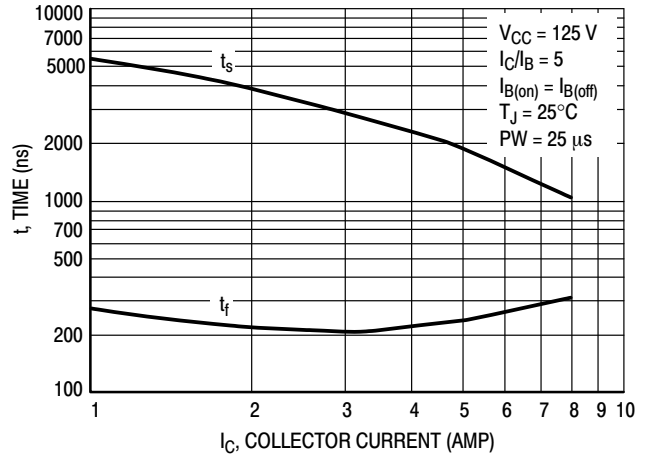


Figure 11. Turn-Off Time (Resistive Load)

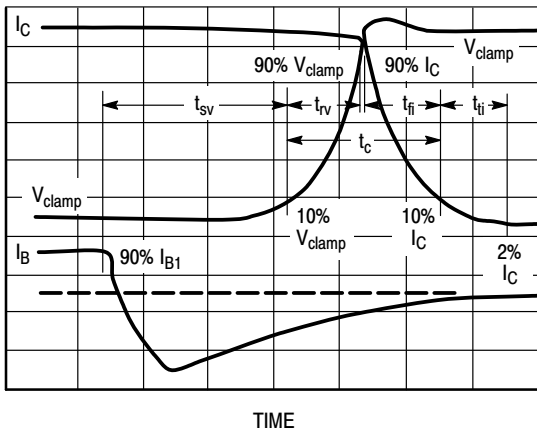


Figure 12. Inductive Switching Measurements

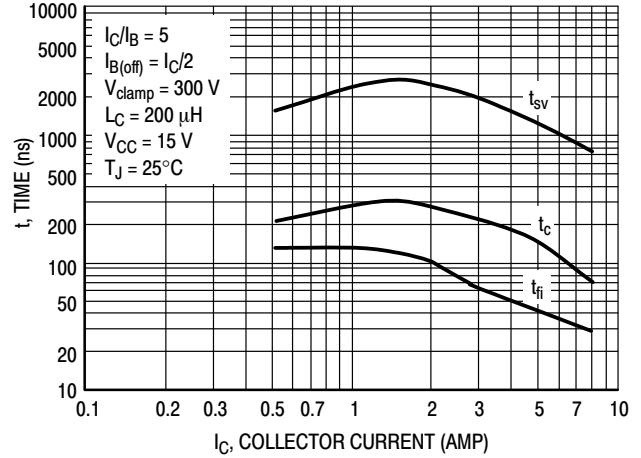
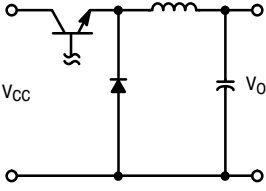
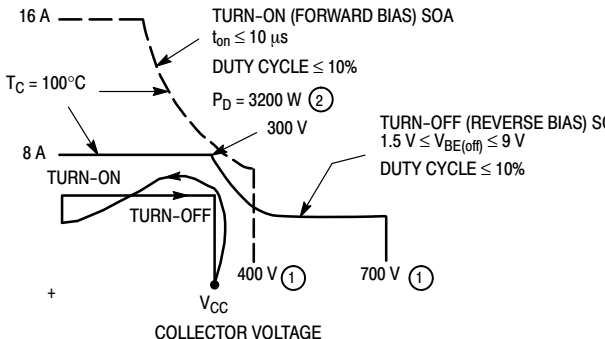
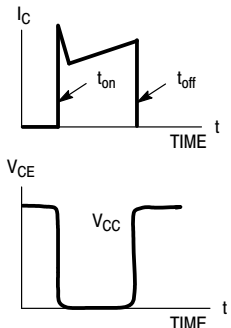
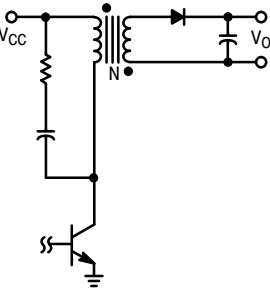
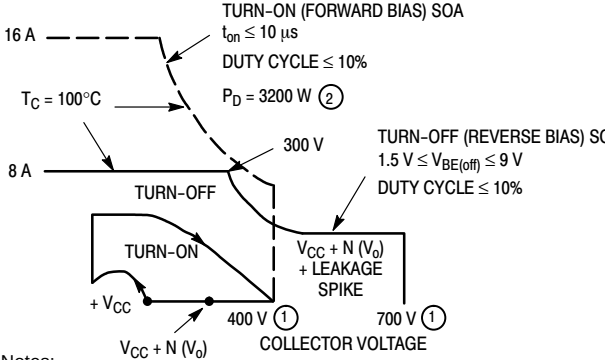
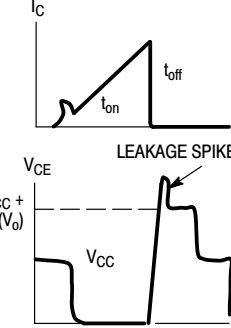
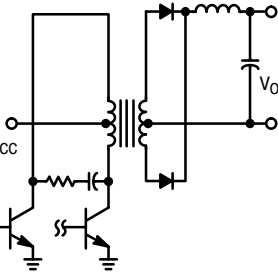
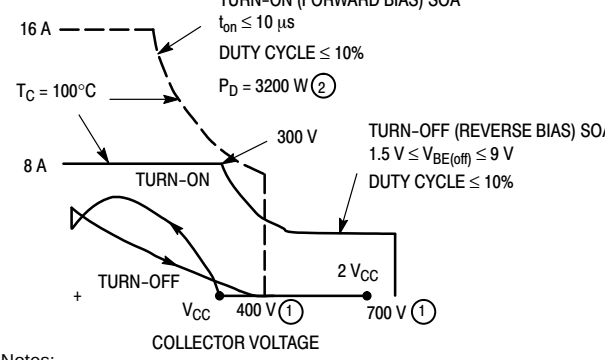
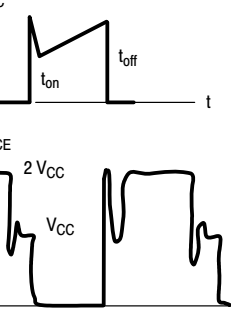
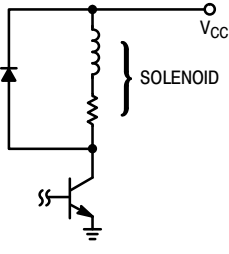
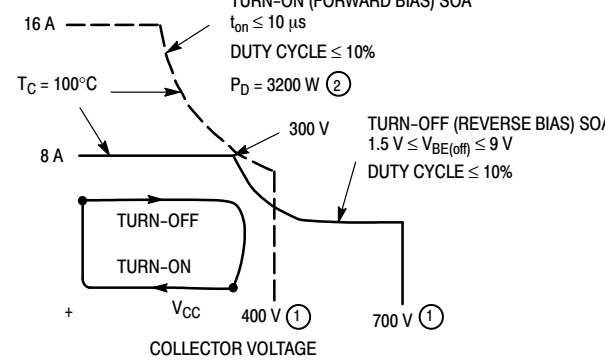
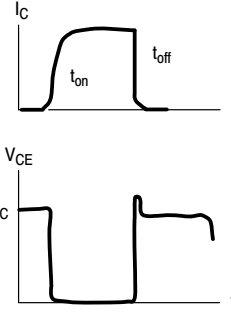


Figure 13. Typical Inductive Switching Times

Table 2. Applications Examples of Switching Circuits

CIRCUIT	LOAD LINE DIAGRAMS	TIME DIAGRAMS
SERIES SWITCHING REGULATOR 	 Notes: ① See AN569 for Pulse Power Derating Procedure.	
FLYBACK INVERTER 	 Notes: ① See AN569 for Pulse Power Derating Procedure.	
PUSH-PULL INVERTER/CONVERTER 	 Notes: ① See AN569 for Pulse Power Derating Procedure.	
SOLENOID DRIVER 	 Notes: ① See AN569 for Pulse Power Derating Procedure.	

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